

FIG. 1

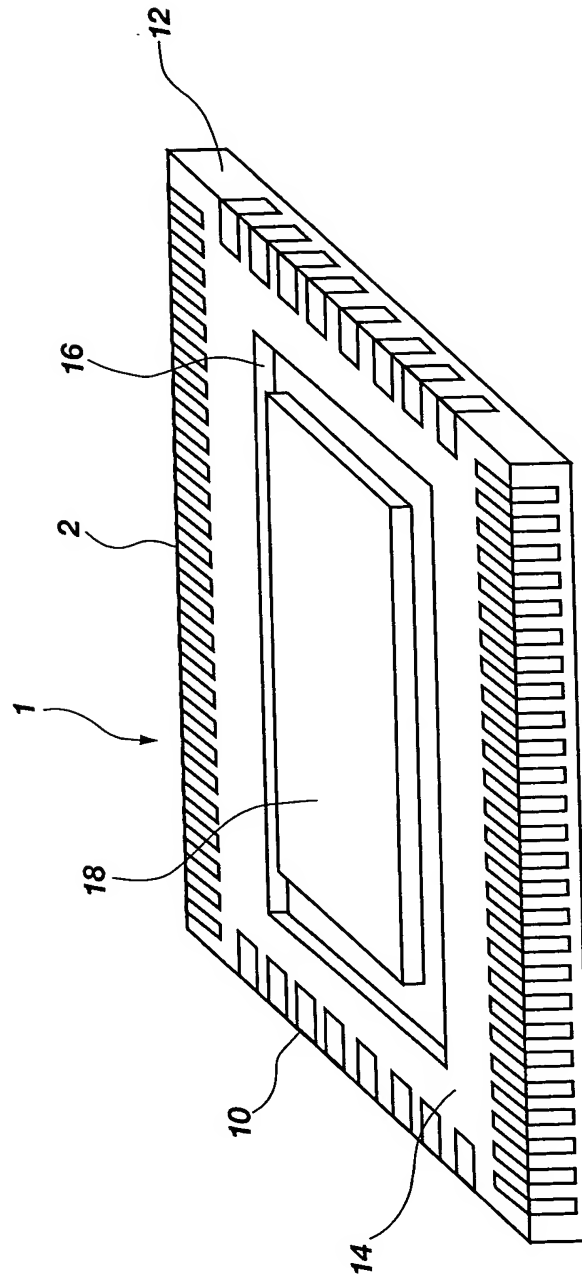
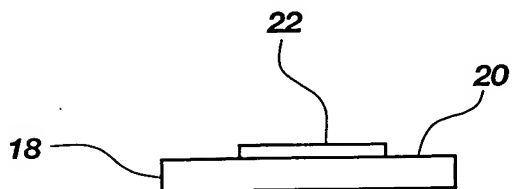


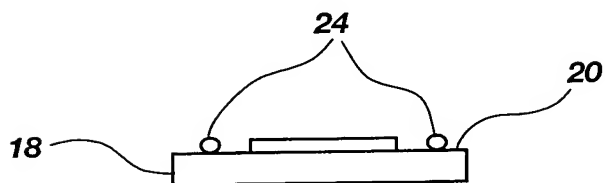
FIG. 2



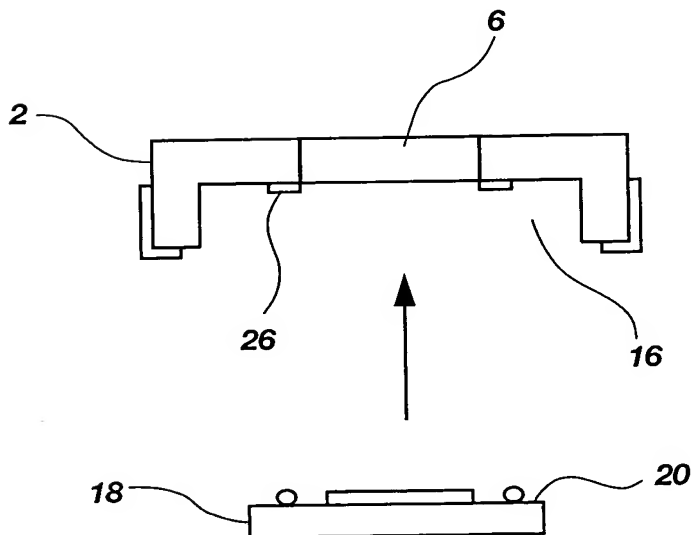
**FIG. 4**



**FIG. 5A**



**FIG. 5B**



**FIG. 5C**

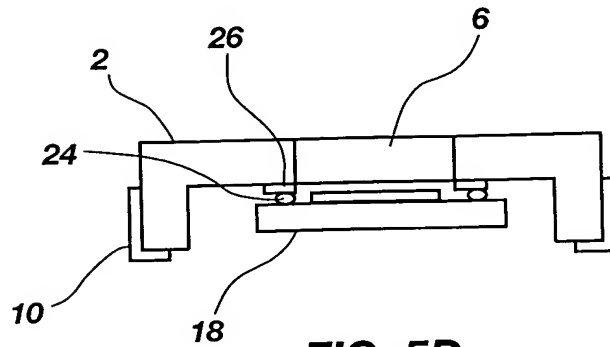


FIG. 5D

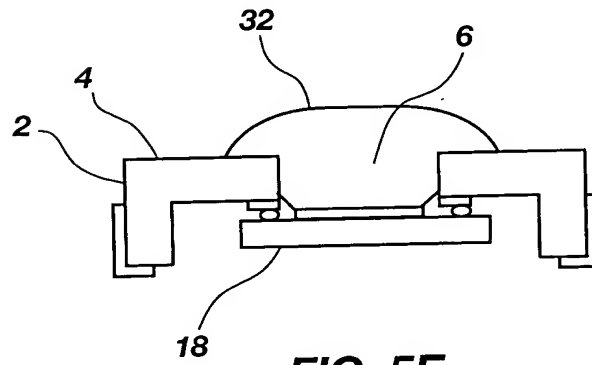


FIG. 5E

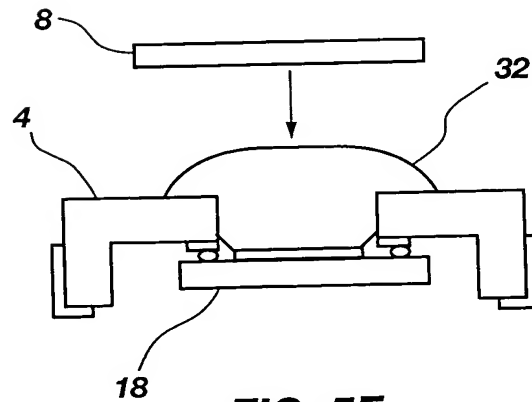


FIG. 5F



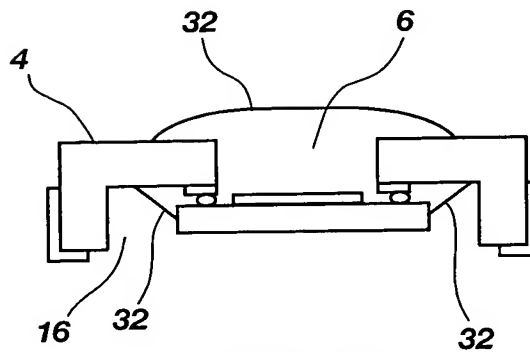
TITLE: LEADLESS PACKAGING FOR IMAGE SENSOR DEVICES  
AND METHODS OF ASSEMBLY

Inventor: Suan Jeung Boon

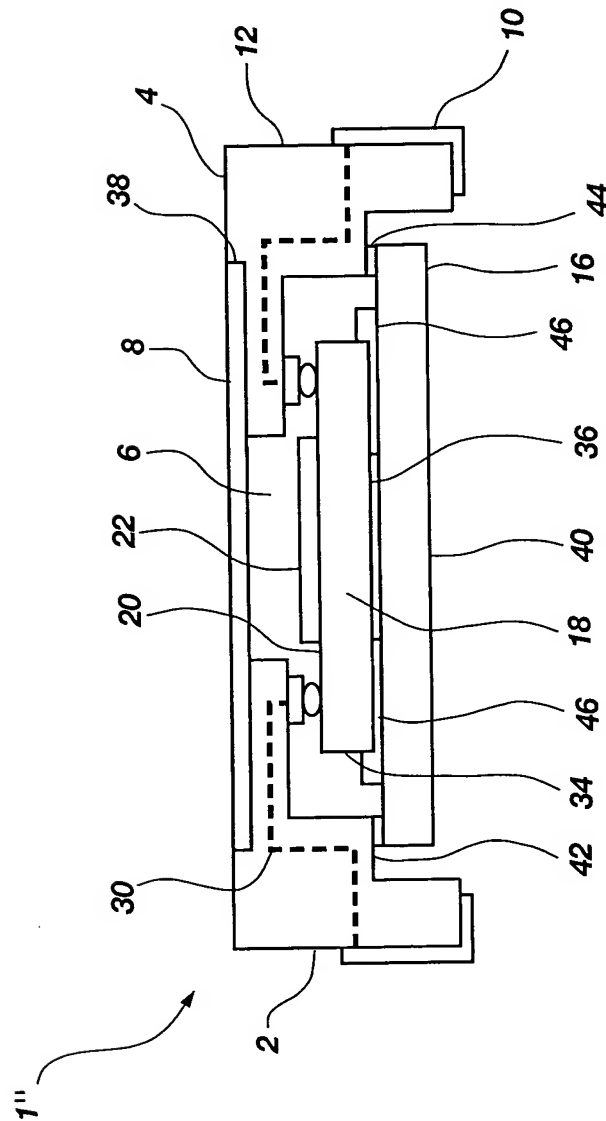
Serial No.: Not yet assigned

Docket No.: 5353.1US (02-0240.01/US)

7/11

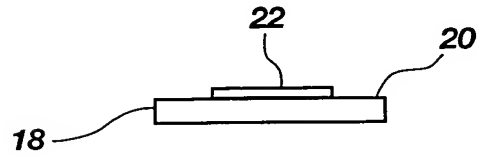


**FIG. 5H**

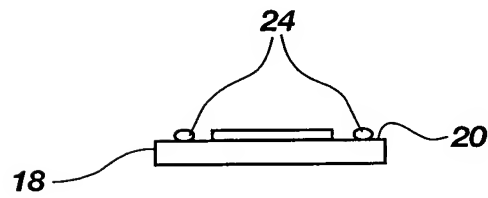


**FIG. 6**

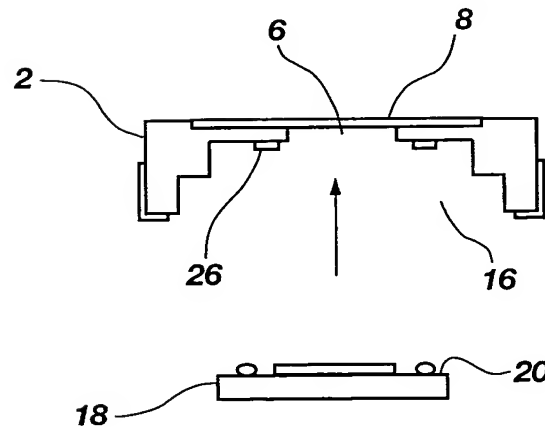




**FIG. 7A**



**FIG. 7B**



**FIG. 7C**

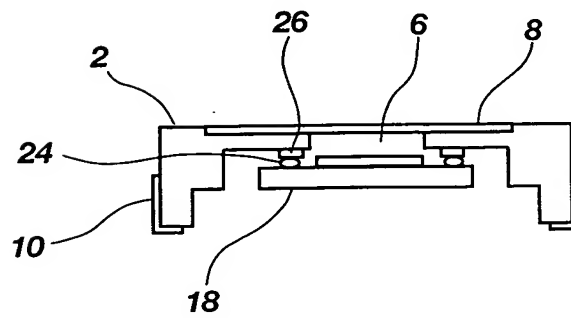


FIG. 7D

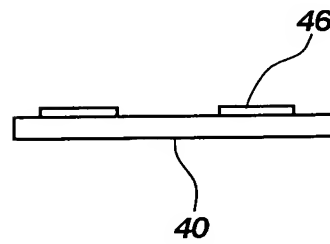


FIG. 7E

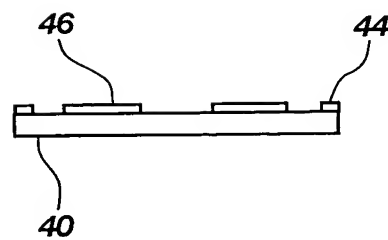


FIG. 7F

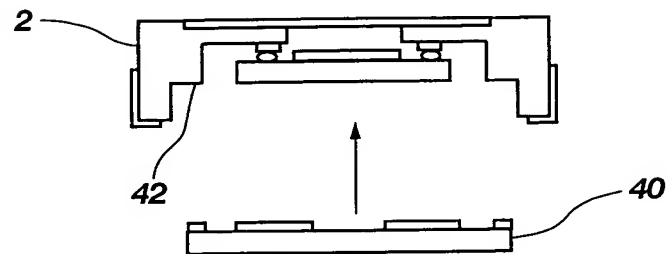


FIG. 7G

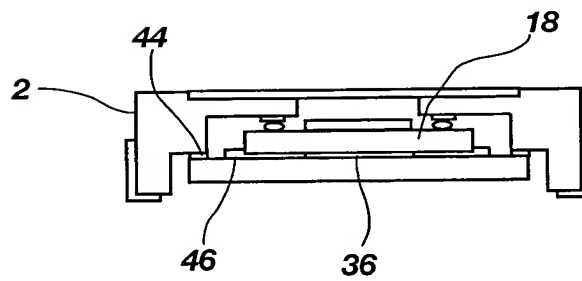


FIG. 7H